

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>YUKI OKUMURA</td> <td>09/10/2013</td> </tr> <tr> <td>YOSHIFUMI MAYA</td> <td>09/11/2013</td> </tr> <tr> <td>YOSHINARI SHOYAMA</td> <td>09/11/2013</td> </tr> <tr> <td>TAKAKO ONISHI</td> <td>09/11/2013</td> </tr> </tbody> </table>		Name	Execution Date	YUKI OKUMURA	09/10/2013	YOSHIFUMI MAYA	09/11/2013	YOSHINARI SHOYAMA	09/11/2013	TAKAKO ONISHI	09/11/2013
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YOSHIFUMI MAYA	09/11/2013										
YOSHINARI SHOYAMA	09/11/2013										
TAKAKO ONISHI	09/11/2013										
RECEIVING PARTY DATA											
Name:	NIHON MEDI-PHYSICS CO., LTD.										
Street Address:	3-4-10, SHINSUNA										
Internal Address:	KOTO-KU										
City:	TOKYO										
State/Country:	JAPAN										
Postal Code:	136-0075										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14128903</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14128903						
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Application Number:	14128903										
CORRESPONDENCE DATA											
Fax Number:	(202)419-7000										
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<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>											
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ATTORNEY DOCKET NUMBER:	7378-132076										
NAME OF SUBMITTER:	KENDREW H. COLTON										

CH \$40.00 14128903

Signature:	/Kendrew H. Colton/
Date:	12/23/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 5 source=Assignment#page1.tif source=Declaration#page1.tif source=Declaration#page2.tif source=Declaration#page3.tif source=Declaration#page4.tif	

Please return signed/recorded to:

Fitch, Even, Tabin & Flannery
1801 K Street, N.W., Suite 401L
Washington, D.C. 20006-1201

USA Patent Appl.
Sole or Joint

For inventions made outside USA
executed with or after application
Atty. Dkt. _____
IFP-1294

NONPROVISIONAL ASSIGNMENT NONPROVISIONAL
OF NONPROVISIONAL APPLICATION

In consideration of the sum of Ten Dollars (\$10.00) and other good and valuable consideration paid to each of the undersigned, to wit:

INSERT (1) Yuki OKUMURA (2) Yoshifumi MAYA
NAME(S) OF (3) Yoshinari SHOYAMA (4) Takako ONISHI
INVENTOR(S) (5) _____ **x box if continued on page 2**

the receipt and sufficiency of which are hereby acknowledged by the undersigned who at the request of, hereby sell(s), assign(s) and transfer(s) unto:

INSERT NIHON MEDI-PHYSICS CO., LTD.,
NAME(S) OF a corporation organized under the law of JAPAN,
ASSIGNEE(S) of 3-4-10, Shinsuna, Koto-ku, Tokyo, 136-0075 JAPAN.
& ADDRESS(ES) _____

(hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all applications including any divisions, continuations, substitutes, and reissues thereof; and all resulting patents, known as

TITLE OF INVENTION NOVEL COMPOUND WITH AMYLOID AFFINITY

for which the undersigned executed an application for Letters Patents of the United States of America:
NOTE ->> (A) even date herewith
(Complete (B) on _____
line A, B and/or C) (C) in U.S. Appl. No. _____ / _____ filed _____

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorney of record in said application shall hereinafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE'S full protection and title in and to the invention hereby transferred.

NOTE ->> The undersigned hereby authorize(s) Fitch, Even, Tabin & Flannery of the above address to insert hereon any further identification necessary or desirable for recordation of this document.

<u>INVENTORS</u>	<u>DATE SIGNED</u>	<u>WITNESSES</u>
1) <u>Yuki Okumura</u> Name: Yuki OKUMURA	<u>Sep 10, 2013</u>	<u>Masahito Toyama</u>
2) <u>Yoshifumi Maya</u> Name: Yoshifumi MAYA	<u>Sep 11, 2013</u>	<u>Akihito Tanaka</u>
3) <u>Yoshinari Shoyama</u> Name: Yoshinari SHOYAMA	<u>Sep 11, 2013</u>	<u>Akihito Tanaka</u>
4) <u>Takako Onishi</u> Name: Takako ONISHI	<u>Sep 16, 2013</u>	<u>Akihito Tanaka</u>
5) _____ Name: _____	_____	_____

**DECLARATION
FOR UTILITY OR
DESIGN
PATENT APPLICATION**

Declaration
Submitted With
Initial Filing

Declaration
Submitted After
Initial Filing

) Attorney Docket:

) Customer No.:

) _____
) First Named Inventor:

) Application Number:

) Filing Date:

) Art Unit:

) Examiner Name:

As a below named inventor, I hereby declare that:

My residence and post office address are as stated below next to my name.

I believe I am the original sole inventor (if only one name is listed below) or an original joint inventor (if plural names are listed below) of a claimed invention in this application and for which a patent is sought on the invention entitled:

NOVEL COMPOUND WITH AMYLOID AFFINITY

(Title of Invention)

the specification of which:

is attached hereto, or

was filed by an authorized person on my behalf on May 29, 2012 as United States Application Number _____ or PCT International Application Number PCT/JP2012/063726, and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

I hereby state that this application was made or was authorized to be made by me as the original sole inventor (if only one name is listed below) or as an original joint inventor (if plural names are listed below) as shown by my signature hereinbelow.

I acknowledge the duty to disclose information which is known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

If checked, the undersigned hereby grants the United States Patent and Trademark Office authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See

Title 37, Code of Federal Regulations, §1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application.

In accordance with Title 37, Code of Federal Regulations, §1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: (1) the above-identified application, (2) any foreign application to which the above-identified application claims priority under Title 35, United States Code, §119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of Title 37, Code of Federal Regulations, §1.55 has been filed in the above-identified United States application, and (3) any United States application from which benefit is sought in the above-identified application.

In accordance with Title 37, Code of Federal Regulations, §1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT international application which designated at least one country other than the United States of America, listed below, and I have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application, on this invention filed by me or my legal representatives or assigns and having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application Number</u>	<u>Country</u>	<u>Foreign Filing Date</u>	<u>Priority Not Claimed</u>
2011-140069	JAPAN	June 24, 2011	

Additional foreign application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:

<u>Provisional Application Number</u>	<u>Provisional Application Filing Date</u>
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Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code, §120, of any prior United States application(s), or under §365(c) of any PCT international application(s) designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application(s) in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information known by me to be material to patentability as defined in Title 37,

Code of Federal Regulations, §1.56, which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

<u>Prior U.S. Application Number</u>	<u>Prior PCT International Application Number</u>	<u>Filing Date of U.S. or PCT International Application</u>	<u>Patent Number (if Applicable)</u>
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Additional U.S. or PCT international application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code.

Full name of sole or one joint inventor:

Yuki OKUMURA
(Given names first, with Family name last)

Inventor's signature:

Yuki Okumura

Date:

Sep 10, 2013

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Full name of one joint inventor:

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Inventor's signature:

Yoshifumi Maya

Date:

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Full name of one
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Inventor's signature:

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joint inventor:

Takako ONISHI
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Takako Onishi

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Residence:

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3-1, Kitasode, Sodegaura-shi, Chiba, 299-0266 JAPAN